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APPLICATION NO. FILING DATE		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/621,611	07/18/2003	Yoichi Momose	116623	2899	
25944	7590 08/24/2005		EXAMINER		
	ERRIDGE, PLC	KIM, RIC	KIM, RICHARD H		
P.O. BOX 19 ALEXANDE	928 UA, VA 22320		ART UNIT	PAPER NUMBER	
			2871		
		DATE MAILED: 08/24/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

-		Applica	tion No.	Applicant(s)			
			611	MOMOSE, YOICHI			
	Office Action Summary	Examin	er	Art Unit			
		Richard		2871			
Period fo	The MAILING DATE of this commun	nication appears on t	he cover sheet with the c	correspondence address			
A SH THE - Exte after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD F MAILING DATE OF THIS COMMUN nsions of time may be available under the provisions SIX (6) MONTHS from the mailing date of this come period for reply specified above is less than thirty (5) period for reply is specified above, the maximum so tre to reply within the set or extended period for reply reply received by the Office later than three months ed patent term adjustment. See 37 CFR 1.704(b).	ICATION. s of 37 CFR 1.136(a). In no nunication. 30) days, a reply within the s tatutory period will apply and y will, by statute, cause the a	event, however, may a reply be tir tatutory minimum of thirty (30) day will expire SIX (6) MONTHS from pplication to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication (35 U.S.C. § 133).	on.		
Status							
1)□	Responsive to communication(s) file	ed on 7 ks (0)					
		2b)☐ This action is	non-final.				
3)□							
Disposit	ion of Claims						
5)□	Claim(s) 1-11 is/are pending in the state (4a) Of the above claim(s) is/accclaim(s) is/accclaim(s) is/are allowed. Claim(s) 1-11 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restrict	re withdrawn from o					
Applicat	ion Papers						
10)⊠	The specification is objected to by the The drawing(s) filed on <u>03 November</u> Applicant may not request that any objected to Replacement drawing sheet(s) including the oath or declaration is objected to	er 2003 is/are: a) action to the drawing(so) be held in abeyance. Securized if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121((d).		
Priority ι	ınder 35 U.S.C. § 119						
12)⊠ a)[Acknowledgment is made of a claim All b) Some * c) None of: 1. Certified copies of the priority 2. Certified copies of the priority 3. Copies of the certified copies application from the Internationsee the attached detailed Office actions	documents have be documents have be of the priority docur anal Bureau (PCT R	een received. een received in Applicati nents have been receive ule 17.2(a)).	on No ed in this National Stage			
Attachmen	• •		0 □ () -	(070,440)			
	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (F	PTO-948)	4) Interview Summary Paper No(s)/Mail Da				
3) 🔲 Inforr	nation Disclosure Statement(s) (PTO-1449 or r No(s)/Mail Date			ratent Application (PTO-152)			

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamada et al. (US 6,013,339) in view of Park et al. (US 6,738,124 B2).

Referring to claim 1, 6, 7, 10 and 11, Yamada et al. discloses an electronic device comprising a pair of substrates (Fig. 5, ref. 12a, 12b); a liquid crystal layer provided between the pair of substrates (13); and a sealing material bonding the pair of substrates to each other and enclosing the liquid crystal layer between the pair of substrate (3); the sealing material containing a photocurable component and a thermosetting component (col. 10, lines 25-27), the photocurable component having a curing rate in the range of from 60% to 95% (col. 16, lines 2-3), and the thermosetting component having a curing rate in the rage of from 60%-90% (col. 16, lines 5-6). Yamada et al. further discloses a method of manufacturing comprising applying an adhesive onto at least one of surface of the pair of substrates to form a closed shape in a region of the surface thereof (Fig. 8, ref. 3); disposing spacers on at least one of the surfaces of the pair of substrates (2); dripping liquid crystal onto at least one of the surfaces of the pair of substrates after the adhesive and spacers are disposed (13), bonding the pair of substrate to each other after the liquid crystal is dripped (col. 19, lines 19-23); and curing the adhesive after the bonding is

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formed, the adhesive being an uncured material which is formed to a sealing material by curing (col. 16, lines 10-15). Furthermore, Yamada et al. discloses the device wherein the liquid crystal is injected through a liquid crystal inlet (Fig. 2, ref. 9). However, the reference does not disclose that the *maximum* curing rate is in the rate of from 60% - 95%.

It would have been obvious to one having ordinary skill in the art at the time the invention was made for the maximum curing rate to be from 60% - 90% since Yamada et al. discloses that the proper curing rate prevents the generation of defect goods in production due to alignment dislocation, and therefore improves production efficiency. Therefore, an artisan having ordinary skill in the art would have known to determine the optimum curing rate of the respective material in order to achieve excellent production efficiency (col. 16, lines 1-15).

Furthermore, Yamada et al. does not disclose a member disposed at a position corresponding to the sealing material, the member at least partially blocking a ultraviolet rays so that the photocurable component at portions of the sealing material that correspond to the member has a curing rate of less than 60%.

Park et al. disclose a member disposed at a position corresponding to the sealing material, the member at least partially blocking an ultraviolet rays so that the photocurable component at portions of the sealing material that correspond to the member has a curing rate of less than 60%. (col. 5, lines 25-39).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to employ a metal wire member disposed at a position corresponding to the sealing material, the member at least partially blocking ultraviolet rays since one would be motivated to ease the cutting process after the bonding process (col. 5, lines 28-29).

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Referring to claims 2 and 3, Yamada et al. discloses a device wherein the sealing material includes a resin containing the photocurable component, a resin containing the photocurable component, a resin containing the thermosetting component, and a resin containing the photocurable component and the thermosetting component is the same molecular chain (col. 16, lines 28-67; col. 17, lines 1-10).

Referring to claim 4, Yamada et al. discloses the device wherein the photocurable component includes at least one of an acrylic group and a methacrylic group (col. 16, lines 28-37).

Referring to claim 5, Yamada et al. discloses that the thermosetting component includes an epoxy group (col. 4, lines 39-40).

Referring to claim 8, Yamada et al. discloses the method previously recited. Yamada et al. further discloses that the curing of the adhesive includes a light irradiation substep of curing the photocurable component (col. 16, lines 10-12), and the amount of light irradiation is 1000 to 6000 mJ/cm² (co. 17, lines 35-36).

Referring to claim 9, Yamada et al. disclose the method previously recited, and further discloses that the curing of the adhesive includes a heating substep of curing the thermosetting component. However, the reference does not disclose that the heating temperature and the heating time in the heating substep being set to 60 to 160 degrees Celsius and 20 to 300 minutes, respectively.

It would have been obvious to one having ordinary skill in the art at the time the invention was made for the heating time in the heating substep being to be set to 60 to 160 degrees Celsius and 20 to 300 minutes, respectively since the time and temperature in which to

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efficiently cure the adhesive is a result effective variable. Determining the optimum time and temperature to cure the adhesive would result in efficient curing.

Referring to claim 11, Yamada et al. and Park et al. disclose the device previously recited, but fails to disclose that the member is at least one of a color filter or a metal wire.

It would have been obvious to one having ordinary skill in the art at the time the invention was made for the masking member to be a color filter since color filters block certain wavelengths from getting through, therefore using a color filter in place of the mask of Park would have been obvious.

Response to Arguments

- 1. Applicant's arguments with respect to claims 1-10 have been considered but are moot in view of the new ground(s) of rejection.
- 2. This action replaces the Final Rejection mailed 6/1/05 and responds to the Amendment filed 3/14/05.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Richard H. Kim whose telephone number is (571)272-2294. The examiner can normally be reached on 9:00-6:30 M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Robert H. Kim can be reached on (571)272-2293. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Richard H Kim Examiner Art Unit 2871

RHK

TARIFUR R. CHOWDHURY
PRIMARY EXAMINER